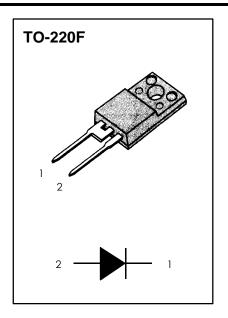
FEATURES

- * Ultrafast with Soft Recovery (Trr < 40ns)
- * Low Forward Voltage ($V_F=0.98V$ at $I_F=20A$)

APPLICATIONS

- * Power Switching Circuits
- * Output rectifiers
- * Freewheeling Diodes
- * Switching Mode Power Supply



MAXIMUM RATINGS

Rating	Symbol	Value	Units
Peak Repetitive Reverse Voltage	V_{RRM}	200	V
Average Rectified Forward Current, T _C =100 °C	I _{F(AV)}	20	Α
Non-repetitive Peak Surge Current	I _{FSM}	200	Α
(Half-wave, Single Phase, 60Hz)			
Operating Junction and Storage Temperature	T_J, T_STG	-65 ~ 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance - Junction to Case	$R_{\theta JC}$	2.5	°C/W
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ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Min	Тур	Max	Units
Maximum Instantaneous Forward Voltage (1)	V_{F}				
(I _F = 20A, T _C = 100 °C)		-	-	1.0	V
$(I_F = 20A, T_C = 25 ^{\circ}C)$		-	-	1.2	
Maximum Instantaneous Reverse Current (1)	I _R				
(Rated DC Voltage, T _C = 100 °C)		-	-	200	μΑ
(Rated DC Voltage, T _C = 25 °C)		-	-	20	
Maximum Reverse Recovery Time	trr	-	-	40	ns
$(I_F = 20A, di/dt = -200A/\mu s)$	Irr	-	-	4.0	Α
	Qrr	-	-	80	nQ
Avalanche Energy	W_{AVL}	0.5	-	-	mJ

(1) Pulse Test : Pulse Width = $300\mu s,\, Duty\,\, Cycle \leq 2.0\%$

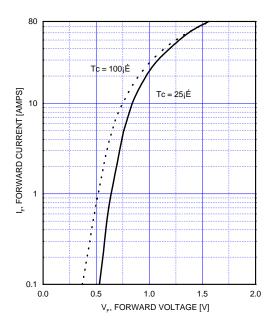


Fig.1 Typical Forward Voltage Drop vs. Forward Current

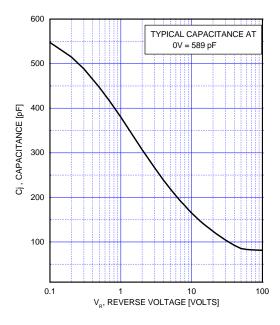


Fig.3 Typical Capacitance

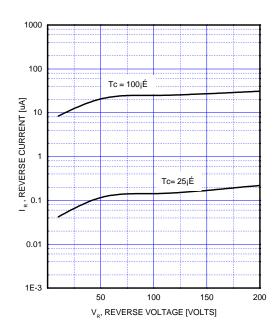


Fig.2 Reverse Voltage vs. Reverse Current

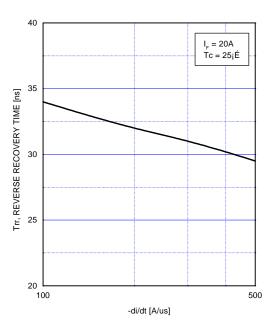
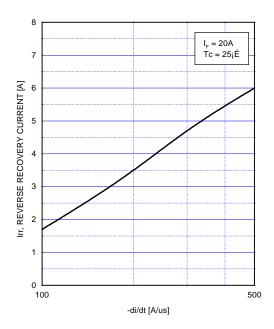


Fig.4 Typical Reverse Recovery Time vs. di/dt





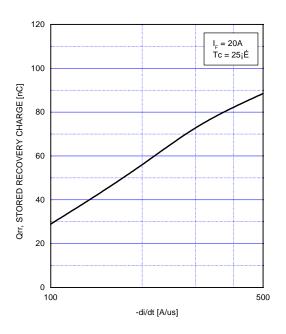
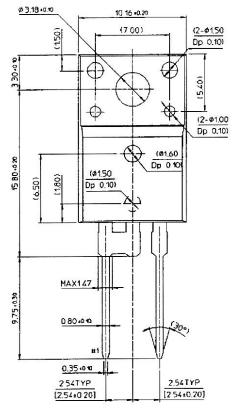
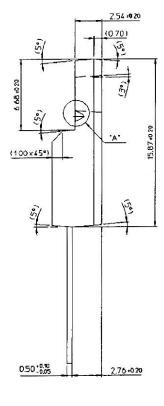


Fig.5 Typical Reverse Recovery Current vs. di/dt

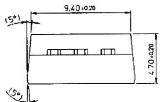
Fig.6 Typical Stored Charge vs. di/dt

PACKAGE DIMENSION

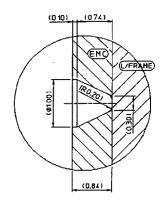




Unit : mm







NOTE

1. THESE DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION

2. () IS REFERENCE

3 [] IS ASSY OUT QUALITY



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FACT Quiet Series $^{\text{TM}}$ Quiet Series $^{\text{TM}}$ SuperSOT $^{\text{TM}}$ -3 FAST $^{\text{TM}}$ SuperSOT $^{\text{TM}}$ -6 GTO $^{\text{TM}}$ SuperSOT $^{\text{TM}}$ -8 HiSeC $^{\text{TM}}$ TinyLogic $^{\text{TM}}$

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